





SICR10650 SICRF10650 650V SIC POWER SCHOTTKY RECTIFIER

Description

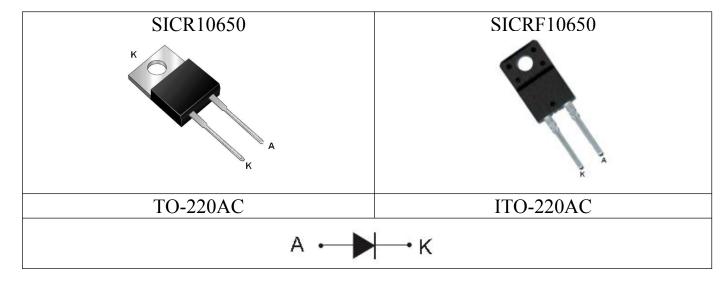
SICR10650/ SICRF10650 are all single SiC Schottky rectifiers packaged in TO-220AC, ITO-220AC case. The device is a high voltage Schottky rectifier that has very low total conduction losses and very stable switching characteristics over temperature extremes. The SICR12600/ SICRF12600 are ideal for energy sensitive, high frequency applications in challenging environments.

Applications

- Alternative energy inverters
- Power Factor Correction (PFC)
- Free-Wheeling diodes
- Switching supply output rectification
- Reverse polarity protection

Features

- 175°C T_J operation
- Ultra-low switching loss
- Switching speeds independent of operating temperature
- Low total conduction losses
- · High forward surge current capability
- High package isolation voltage
- Guard ring for enhanced ruggedness and long term reliability
- Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request



Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ \end{array}$	-	650	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=150°C, rectangular wave form	10	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse, T _C = 25 °C	110	А

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Electrical Characteristics:

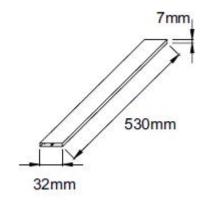
Characteristics	Symbol Condition		Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	V _{F1} @ 10A, Pulse, T _J = 25 °C		1.7	٧
	V _{F2}	@ 10A, Pulse, T _J = 175 °C	1.75	2.5	٧
Reverse Current at DC condition*	I _{R1}	$@V_R = \text{rated } V_R$ $T_J = 25 ^{\circ}\text{C}$	25	100	μА
Reverse Current *	I _{R2}	$@V_R = \text{rated } V_R$ $T_J = 175 ^{\circ}\text{C}$	32	200	μА
Junction Capacitance		@V _R = 0V, T _C = 25 °C, f _{SIG} = 1MHz	695	740	
	C⊤	$@V_R = 200V, T_C = 25 ^{\circ}C, f_{SIG} = 1MHz$	73	78	pF
		$@V_R = 400V, T_C = 25 ^{\circ}C, f_{SIG} = 1MHz$	70	75	
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%

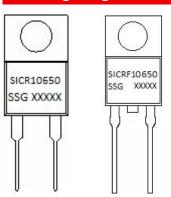
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _{θJC}	DC operation	1.36	°C/W
Approximate Weight	wt	-	1.8	g
Case Style	TO-220AC			

Tube Specification



Marking Diagram



Where XXXXX is YYWWL

 SICR
 = Device Type

 F
 = Package type

 10
 = Forward Current (10A)

 650
 = Reverse Voltage (650V)

 SSG
 = SSG

SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0







Ratings and Characteristics Curves

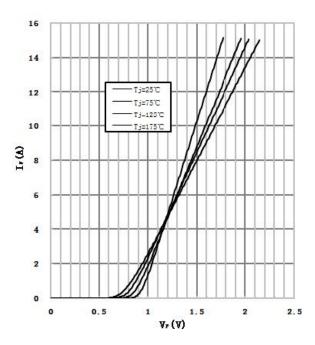


Fig.1-Typical Forward Voltage Characteristics

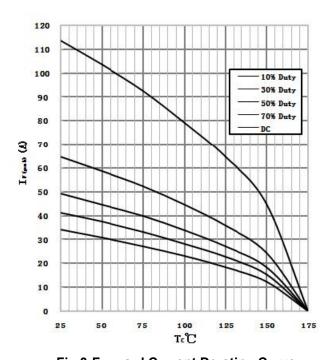


Fig.3-Forward Current Derating Curve

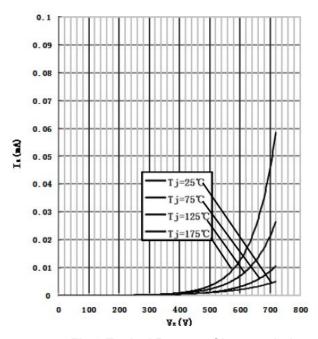


Fig.2-Typical Reverse Characteristics

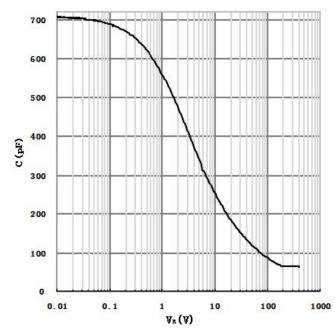


Fig.4-Typical Junction Capacitance

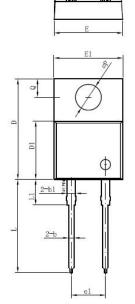


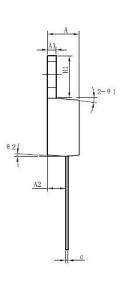
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Mechanical Dimensions TO-220AC





Symbol	Dimensions in millimeters			
- Cymbol	Min.	Typical	Max.	
Α	4.40	4.70	4.85	
A1	1.17	1.27	1.37	
A2	2.40	2.69	2.89	
b	0.61	0.81	0.96	
b1	1.17	1.27	1.37	
С	0.31	0.38	0.70	
D	14.64	14.94	15.75	
D1	8.50	8.07	8.90	
E	10.00	10.16	10.40	
E1	9.98	10.18	10.38	
e1	4.95	5.08	5.18	
H1	6.04	6.24	6.60	
L	13.00	13.86	14.08	
L1	3.50	3.80	3.96	
ФР	3.74	3.84	4.04	
Q	2.54	2.74	2.95	
Θ1		5°		
Θ2		4°		
Θ3		4°		

Ordering Information

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Device	Package	Plating	Weight	Shipping
SICR10650	TO-220AC	Pure Sn	1.8g	50pcs / tube
SICRF10650	ITO-220AC	Pure Sn	1.8g	50pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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